



# Extreme Fusion X1

RG-EFX1-TG15-R1



Extreme Fusion X1 is created for extreme users on highest level, which achieves the best thermal conductivity from your CPU, GPU or even Chipset to your cooler. It is non-curing and non-electrical conductive traits and avoids any short circuit incidence. Extreme Fusion X1 is a Japan made thermal compound with great durability. It does not show decreasing performance after long period of time.

## Features

- Ultra High Thermal Conductivity (9.5W/mK)
- Over twice the thermal conductivity of Standard TIM
- Beats Silver based TIM
- Short circuit proof
- Thermal Compound made in Japan

## Packing Information

EAN Code	4719512038529
UPC Code	884102017957
Package Dimensions	189 x 114 x 20mm (7.4 x 4.5 x 0.8 in)
Carton Dimensions	437 x 415 x 290 mm (17.2 x 16.3 x 11.4 in)
Unit / Carton	100 pcs
Carton / Pallet	28 Carton

## Specifications

Color	Gray
Specific Gravity (25°C)	2.6
Thermal Conductivity (W/m-K)	9.5
Volume (ml)	1.5
Net Weight (g)	4.15
Scraper	Yes